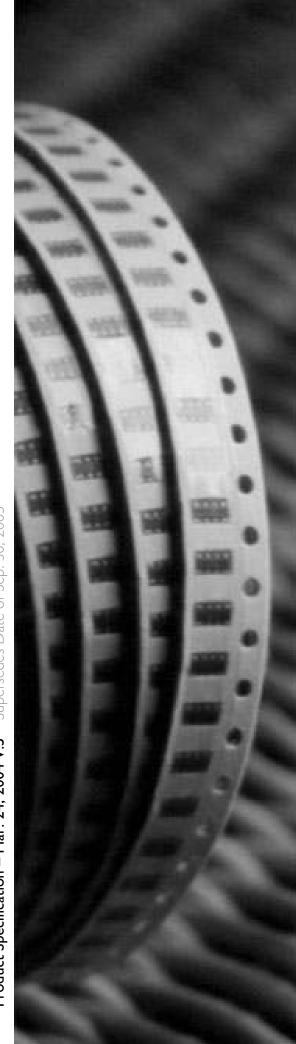


DATA SHEET

CHIP RESISTORS ARRAY YC164 (8Pin/4R) 5%; 1%



Product Specification – Mar. 24, 2004 V.5 Supersedes Date of Sep. 30, 2003



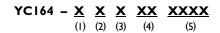
YAGEO

SCOPE

This specification describes YCI64 series chip resistors made by thick film process.

ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing style, temperature coefficient, special type and resistance value.



(I) TOLERANCE

 $F = \pm 1\%$ $J = \pm 5\%$

(2) PACKAGING TYPE

R = Paper taping reel

(3) TEMPERATURE CHARACTERISTIC OF RESISTANCE

 $G = \pm 200 \text{ppm/}^{\circ}\text{C}$ - = Base on spec

(4) SPECIAL TYPE

07 = 7 inch dia. Reel 13 = 13 inch dia. Reel

(5) RESISTANCE VALUE:

56R, 560R, 5K6, 56K, 1M.

MARKING

YC164



Fig. I 5% Marking, Value=5.6Ω

First two digits for significant figure and 3rd digit for number of zeros

Letter R: decimal place

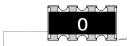


Fig. 2 Jumper=Zero Ohm

Letter 0: Jumper chip (0 ohm)

DIMENSION

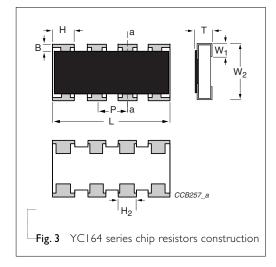
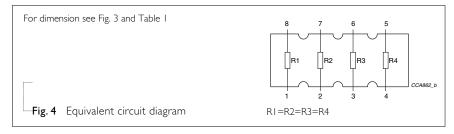


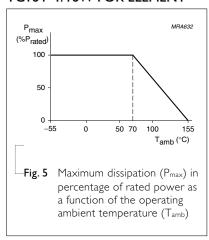
Table I	
TYPE	YC164
B (mm)	0.3±0.15
H (mm)	0.65±0.05
P (mm)	0.8±0.05
L (mm)	3.2±0.15
H_2 (mm)	0.5±0.15
T (mm)	0.6±0.1
W_1 (mm)	0.3±0.15
W ₂ (mm)	1.6±0.15

SCHEMATIC



POWER RATING

RATED POWER AT 70°C, YC164=1/16W FOR ELEMENT



RATED VOLTAGE:

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V=\sqrt{(P \times R)}$$

Where

V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value (Ω)

ELECTRICAL CHARACTERISTICS

Table 2

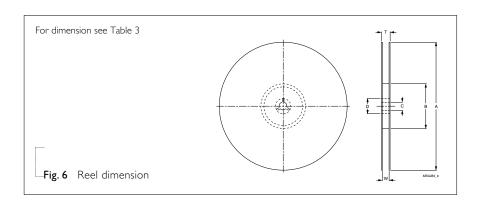
CHARACTERISTICS	YC164 1/16W		
Operating Temperature Range	–55°C to +155°C		
Maximum Working Voltage	50V		
Maximum Overload Voltage	100V		
Dielectric Withstanding Voltage	100V		
Number of Resistors	4		
Posistanco Pongo	10Ω to $1M\Omega$		
Resistance Range	Zero Ohm Jumper $< 0.05 \Omega$		
Temperature Coefficient	±200ppm/°C		
lumpor Critoria	Rated Current 1.0A		
Jumper Criteria	Maximum Current 2.0A		



TAPING REEL

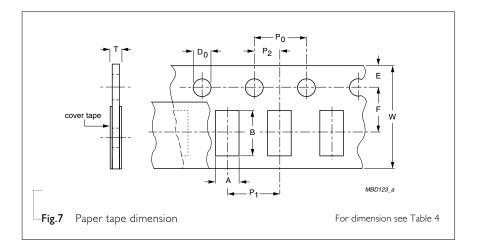
YAGEO

Table 3	
DIMENSION	YC164
Tape Width	8mm
ØA (mm)	180+0/-3
ØB (mm)	60+1/-0
ØC (mm)	13.0±0.2
ØD (mm)	21±0.8
W (mm)	9.0±0.3
T (mm)	.4±



PAPER TAPE SPECIFICATION

Table 4	
DIMENSION	YC164
A (mm)	2.0±0.1
B (mm)	3.5±0.1
W (mm)	8.0±0.2
E (mm)	1.75±0.1
F (mm)	3.5±0.05
P ₀ (mm)	4.0±0.1
P _I (mm)	4.0±0.1
P ₂ (mm)	2.0±0.05
OD_0 (mm)	1.5+0.1/-0
T (mm)	0.85±0.1



PACKING METHOD

LEADER/TRAILER TAPE SPECIFICATION

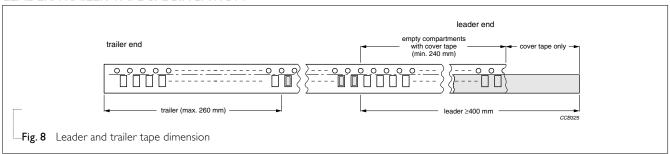


Table 5 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	YC164
Paper Taping Reel (R)	7" (178 mm)	5,000
	13" (330 mm)	20,000



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ГҮРЕ	TEST METHOD				ACCEPTANCE STANDARD
Temperature Coefficient of Resistance (T.C.R.)	rature Measure resistance at Formula ent of +25°C or specified room trance temperature as R ₁ , then $T.C.R. = \frac{R_2 - R_1}{R_1 - R_2} \times 10^6 \text{ (ppm/°C)}$			ture e re in ohms	Refer to table 2
Thermal Shock	At $-55\pm3^{\circ}$ C for 2 minutes and at $+155\pm2^{\circ}$ C for 2 minutes as one cycle. After 5 cycles, the specimen shall be stabilized at room temp. Measure the resistance to determine Δ R/R(%) after one more hour.			$\pm (0.5\% + 0.05\Omega)$ for 1% tol. $\pm (1\% + 0.05\Omega)$ for 5% tol.	
Low Temperature Operation	stabilization at this temperature, full rated working voltage shall be applied for 45			$\pm (0.5\% + 0.05\Omega)$ for 1% tol . $\pm (1.0\% + 0.05\Omega)$ for 5% tol. No visible damage	
Short Time Overload	for 5 seconds. Have the specimen stabilized at room temperature for 30 minutes			$\pm (1.0\% + 0.05\Omega)$ for 1% tol. $\pm (2.0\% + 0.05\Omega)$ for 5% tol. No visible damage	
Insulation Resistance	ion Place the specimen in the jig a	and apply a rated	Туре	YC164	≥10,000ΜΩ
	continues overload voltage (R.C.O.V) for one minute as shown. Measure the insulation resistance.		Voltage (DC)	100V	
Dielectric Withstand Voltage	Place the specimen in the jig ar specified value continuous over shown for one minute.		Type Voltage (AC)	YC164	Breakdown voltage> specification and without open/short
Resistance To Soldering Heat	g specimen stabilized at room temperature for 30 minutes minimum.		$\pm (0.5\% + 0.05\Omega)$ for 1% tol. $\pm (1.0\% + 0.05\Omega)$ for 5% tol. No visible damage		



TYPE	TEST METHOD	ACCEPTANCE STANDARD	
Moisture Resistance	Place the specimen in the test chamber and sub- one of which consists of the steps 1 to 7 as figu 1,000 hours. Have the specimen stabilized at ro- testing. Measure the resistance to determine $\Delta R/R(\%)$.	$\pm (0.5\% + 0.05\Omega)$ for 1% tol. $\pm (2.0\% + 0.05\Omega)$ for 5% tol. No visible damage	
Life	Place the specimen in the oven at $70\pm2^{\circ}$ C. App at the 1.5 hours on and 0.5 hour off cycle. The Have the specimen stabilized at room temperatesting. Measure the Δ R/R(%).	$\pm (1.0\% + 0.05\Omega)$ for 1% tol. $\pm (3.0\% + 0.05\Omega)$ for 5% tol. No visible damage	
Solderability	Immerse the specimen in the solder pot at 235±5°C for 5 sec.		At least 95% solder coverage on the termination
Bending Strength	Mount the specimen on a test board as shown in the figure 9. Slowly apply the force till the board is bent for 5 ± 1 sec. Measure the Δ R/R(%) at this position.	Type YC164 Bent Distance (d) Imm Position before bend 20 Teeting printed circuit board Fig. 9 Principle of the bending test	$\pm (1.0\% + 0.05\Omega)$ for 1% tol. $\pm (1.0\% + 0.05\Omega)$ for 5% tol. No visible damage

